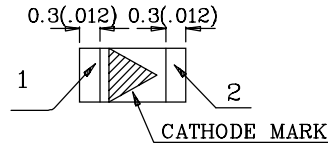
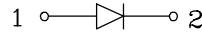
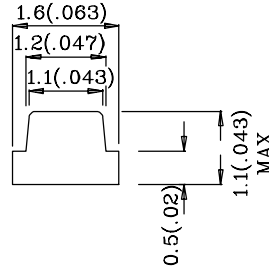
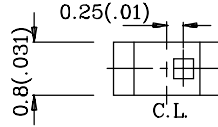


1.6x0.8mm SMD CHIP LED LAMP



SUN LED

ZMY53W



Notes:

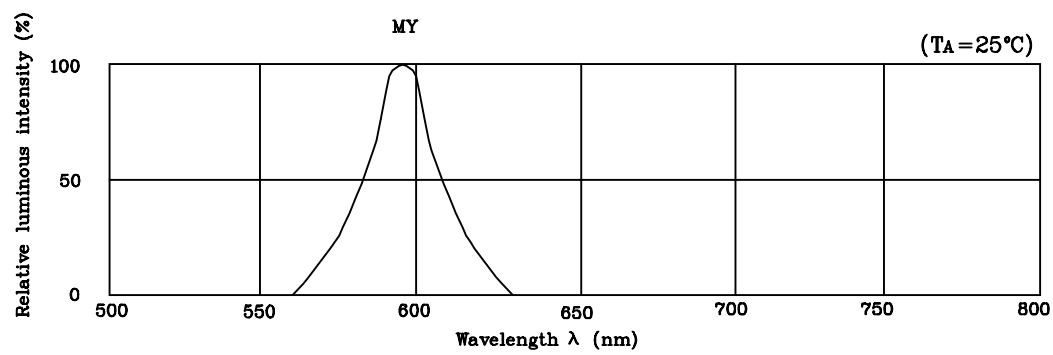
1. All dimensions are in millimeters (inches).
2. Tolerance is $\pm 0.1(0.004)$ unless otherwise noted.

Absolute maximum ratings ($T_A=25^\circ\text{C}$)		MY (InGaAlP)	Unit
Reverse Voltage	V_R	5	V
Forward Current	I_F	30	mA
Forward Current (Peak) 1/10Duty cycle 0.1ms pulse width	i_{FS}	150	mA
Power dissipation	P_T	125	mW
Operation Temperature	T_A	-40 ~ +85	$^\circ\text{C}$
Storage Temperature	T_{stg}		

Operating Characteristics ($T_A=25^\circ\text{C}$)		MY (InGaAlP)	Unit
Forward voltage (typ.) ($I_F=20\text{mA}$)	V_F	2.0	V
Forward voltage (max.) ($I_F=20\text{mA}$)	V_F	2.4	V
Reverse current ($V_R=5\text{V}$)	I_R	10	μA
Wavelength at peak emission ($I_F=20\text{mA}$)	λ_{peak}	590	nm
Spectral Line half-width ($I_F=20\text{mA}$)	$\Delta\lambda$	20	nm
Capacitance ($V_F=0$, $f=1\text{MHz}$)	C	33	pF

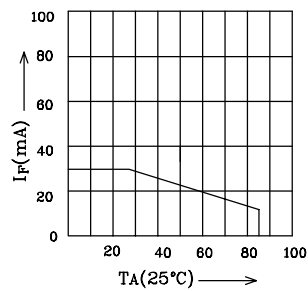
Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity ($I_F=20\text{mA}$) mcd		Wavelength nm	Viewing Angle
				min.	typ.		
ZMY53W	yellow	InGaAlP	water clear	40	60	590	120°

ZMY53W

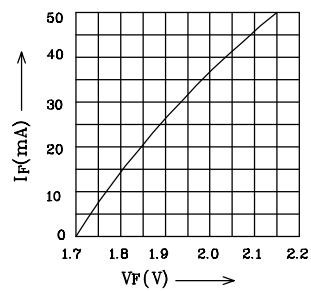


◆MY

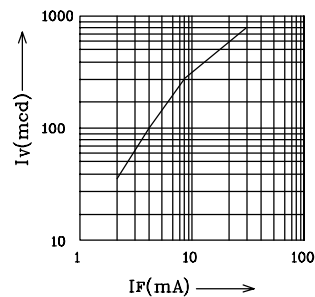
Forward current derating curve



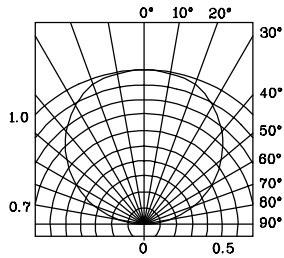
Forward current Vs. Forward voltage



Luminous intensity Vs. Forward current



Radiation Characteristics

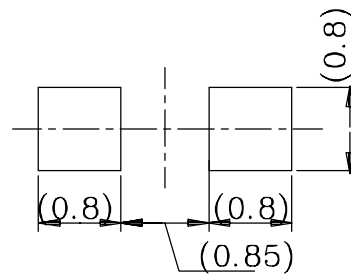


ZMY53W

❖ SMT Reflow Soldering Instructions



❖ Recommended Soldering Pattern (Units : mm)



ZMY53W

❖ Tape Specification (Units : mm)

